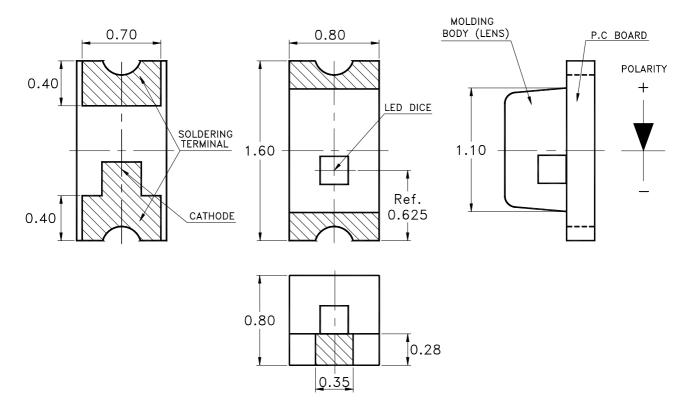


Property of Lite-On Only

#### **Features**

- \* Ultra bright AlInGaP Chip LED.
- \* Package in 8mm tape on 7" diameter reels.
- \* Compatible with automatic placement equipment.
- \* Compatible with infrared and vapor phase reflow solder process.
- \* EIA STD package.
- \* I.C. compatible.

## Package Dimensions



Part No.	Lens	Source Color
LTSN-C190QF	Water Clear	AllnGaP Orange

#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm$  0.10 mm (.004") unless otherwise noted.

Part No.: LTSN-C190QF Page: 1 of 10

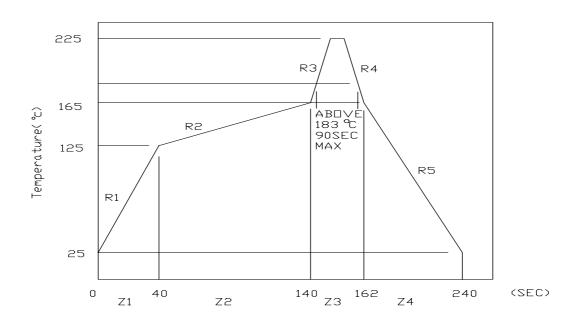


Property of Lite-On Only

# Absolute Maximum Ratings At Ta=25℃

Parameter	LTSN-C190QF	Unit	
Power Dissipation	75	mW	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	mA	
DC Forward Current	30	mA	
Derating Linear From 25°C	0.4	mA/°C	
Reverse Voltage	5	V	
Operating Temperature Range	-55°C to +85°C		
Storage Temperature Range	-55°C to +85°C		
Wave Soldering Condition	260°C For 5 Seconds		
Infrared Soldering Condition	260°C For 5 Seconds		
Vapor Phase Soldering Condition	215°C For 3 Minutes		

## Suggest IR Reflow Condition:



Part No.: LTSN-C190QF Page: 2 of 10



Property of Lite-On Only

# Electrical Optical Characteristics At Ta=25°C

Parameter	Symbol	Part No. LTSN-	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	C190QF	71.0	130.0		mcd	IF = 20mA Note 1
Viewing Angle	2 0 1/2	C190QF		130		deg	Note 2 (Fig.6)
Peak Emission Wavelength	λΡ	C190QF		611		nm	Measurement @Peak (Fig.1)
Dominant Wavelength	λd	C190QF		605		nm	Note 3
Spectral Line Half-Width	Δλ	C190QF		17		nm	
Forward Voltage	VF	C190QF		2.0	2.4	V	IF = 20mA
Reverse Current	IR	C190QF			100	$\mu$ A	VR = 5V
Capacitance	С	C190QF		40		PF	VF = 0 f = 1MHZ

Notes: 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.

- 2.  $\theta$  1/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3. The dominant wavelength,  $\lambda$  d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

Part No.: LTSN-C190QF Page: 3 of 10



Property of Lite-On Only

# **Bin Code List**

Luminous Intensity Unit:		mcd @20mA
Bin Code	Min.	Max.
Q	71.0	112.0
R	112.0	180.0
S	180.0	280.0

Tolerance on each Intensity bin is +/-15%

Dominant Wavelength		: nm @20mA
Bin Code	Min.	Max.
P	600.0	603.0
Q	603.0	606.0
R	606.0	609.0
S	609.0	612.0

Tolerance for each Dominate Wavelength bin is +/- 1nm

Part No.: LTSN-C190QF Page: of 10



Property of Lite-On Only

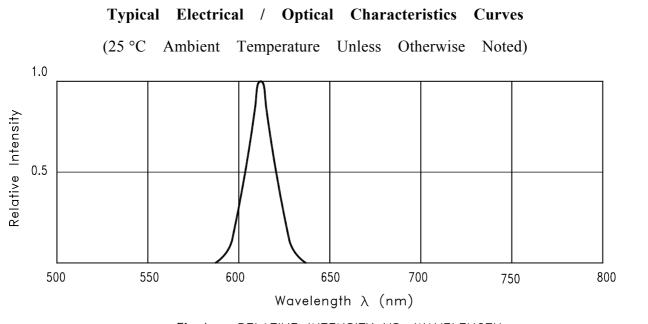


Fig.1 RELATIVE INTENSITY VS. WAVELENGTH

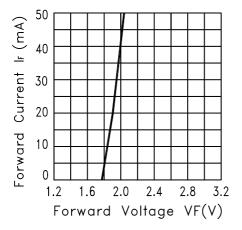


Fig.2 FORWARD CURRENT VS.
FORWARD VOLTAGE

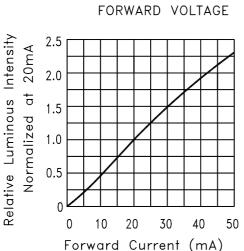


Fig.4 RELATIVE LUMINOUS
INTENSITY VS. FORWARD CURRENT

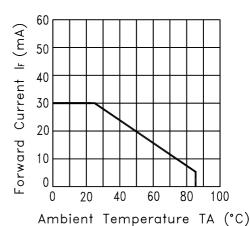


Fig.3 FORWARD CURRENT
DERATING CURVE

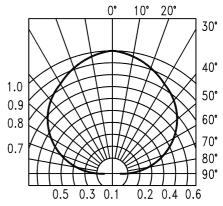


Fig.6 SPATIAL DISTRIBUTION

Part No.: LTSN-C190QF Page: 5 of 10

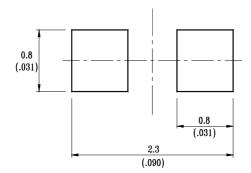


Property of Lite-On Only

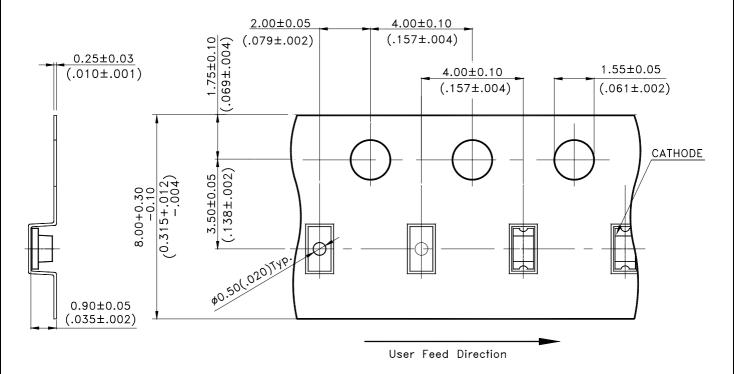
# Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If clean is necessary, immerse the LED in ethyl alcohol or in isopropyl alcohol at normal temperature for less one minute.

## **Suggest Soldering Pad Dimensions**



# **Package Dimensions Of Tape And Reel**



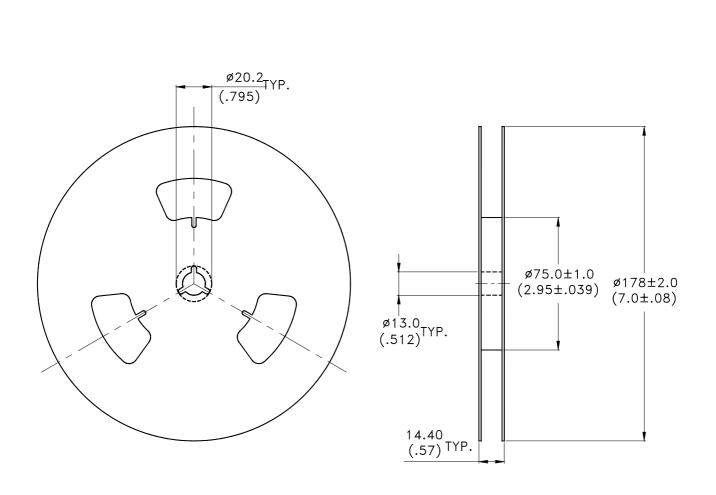
#### Notes:

1. All dimensions are in millimeters (inches).

Part No.: LTSN-C190QF Page: 6 of 10



Property of Lite-On Only



#### Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel-3000 pieces per reel.
- 3. Minimum packing quantity is 500 pcs for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with ANSI/EIA 481-1-A-1994 specifications.

Part No.: LTSN-C190QF	Page:	7	of	10	
-----------------------	-------	---	----	----	--



Property of Lite-On Only

# **CAUTIONS**

# 1. Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

#### 2. Storage

The storage ambient for the LEDs should not exceed 30°C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are IR-reflowed within one week. For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient. LEDs stored out of their original packaging for more than a week should be baked at about 60 deg C for at least 24 hours before solder assembly.

#### 3. Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

### 4. Soldering

Recommended soldering conditions:

Reflow soldering		Wave Soldering		Soldering iron		
Pre-heat Pre-heat time Peak temperature Soldering time	240°C Max.		100°C Max. 60 sec. Max. 260°C Max. 10 sec. Max.	Soldering time	300°C Max. 3 sec. Max. (one time only)	

#### 5. Drive Method

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.



- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

#### 6. ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED.

Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

Part No.: LTSN-C190QF	Page:	8	of	10	
-----------------------	-------	---	----	----	--



Property of Lite-On Only

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "lightup" and Vf of the suspect LEDs at low currents.

The Vf of "good" LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.

Chip ESD level	Machine Mode	Human Body Mode
InGaN / Sapphire	100 V	300 V
AlInGaP	200 V	500 V
InGaN / SiC	600 V	1000 V

# 7. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
Endurance Test	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C,RH= 90∼95% *Test Time= 240HRS±2HRS	MIL-STD-202F:103B(1980) JIS C 7021:B-11(1982)
	High Temperature Storage	Ta= 105±5°C *Test Time= 1000HRS (-24HRS,+72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,+72H RS)	JIS C 7021:B-12 (1982)
	Temperature Cycling	$105^{\circ}\text{C} \sim 25^{\circ}\text{C} \sim -55^{\circ}\text{C} \sim 25^{\circ}\text{C}$ 30mins 5mins 30mins 5mins 10  Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021:A-4(1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times $85 \pm 5^{\circ}\text{C} \sim -40^{\circ}\text{C} \pm 5^{\circ}\text{C}$ 10mins 10 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
Environmental	Solder Resistance	T.sol= $260 \pm 5^{\circ}$ C Dwell Time= $10 \pm 1$ secs	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021:A-1(1982)
Test	IR-Reflow	Ramp-up rate(183°C to Peak) +3°C / second max Temp. maintain at 125(±25)°C 120 seconds max Temp. maintain above 183°C 60-150 seconds Peak temperature range 235°C+5/-0°C Time within 5°C of actual Peak Temperature (tp) 10-30 seconds Ramp-down rate +6°C/second max	MIL-STD-750D:2031.2(1995) J-STD-020(1999)
	Solderability	T.sol= $235 \pm 5^{\circ}$ C Immersion time $2\pm 0.5$ sec Immersion rate $25\pm 2.5$ mm/sec Immersion rate $25\pm 2.5$ mm/sec Coverage $\geq 95\%$ of the dipped surface	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) IEC 68 Part 2-20 JIS C 7021:A-2(1982)

#### 8. Others

The appearance and specifications of the product may be modified for improvement without prior notice.

Part No.: LTSN-C190QF	Page:	9	of	10	
-----------------------	-------	---	----	----	--



Property of Lite-On Only

## 9. Suggested Checking List

## Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

#### Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

#### Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wears wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date? Note: \*50V for Blue LED.

## **Device Handling**

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycles?

#### Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

Part No.: LTSN-C190QF Page: 10 of 10

# This datasheet has been downloaded from:

www. Data sheet Catalog.com

Datasheets for electronic components.